

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SEUNG EUN CHUNG	01/17/2018
	JIN HAN KIM	01/18/2018
	YONG SOON PARK	01/17/2018
	SUNG CHAN YUN	01/17/2018
	DONG WOO LEE	01/18/2018
	SEOK-MO CHANG	01/18/2018
	HEE-SOO JEONG	01/18/2018
	JIN YOUNG CHOI	01/18/2018
RECEIVING PARTY DATA		
Name:	SAMSUNG ELECTRONICS CO., LTD.	
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU	
City:	SUWON-SI, GYEONGGI-DO	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	16677	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15874564	
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	972-628-3600	
Email:	patents@munckwilson.com	
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Address Line 4:	DALLAS, TEXAS 75380	
ATTORNEY DOCKET NUMBER:	PSD16-0374-US0	
NAME OF SUBMITTER:	WILLIAM A. MUNCK	
SIGNATURE:	/William A. Munck, Reg. #39,308/	

DATE SIGNED:	01/18/2018
Total Attachments: 5 source=PSD16-0374-US0 (SAMS14-60374) Assignment (partial)#page1.tif source=PSD16-0374-US0 (SAMS14-60374) Assignment (partial)#page2.tif source=PSD16-0374-US0 (SAMS14-60374) Assignment (partial)#page3.tif source=PSD16-0374-US0 (SAMS14-60374) Assignment (partial)#page4.tif source=PSD16-0374-US0 (SAMS14-60374) Assignment (partial)#page5.tif	

ASSIGNMENT

WHEREAS, We, Seung Eun CHUNG, resident of Yongin-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Da Eun KIM, resident of Seoul, Republic of Korea, citizen of Republic of Korea, Jin Han KIM, resident of Suwon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Yong Soon PARK, resident of Seoul, Republic of Korea, citizen of Republic of Korea, Sung Chan YUN, resident of Suwon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Dong Woo LEE, resident of Yongin-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Seok-Mo CHANG, resident of Incheon, Republic of Korea, citizen of Republic of Korea, Hee-Soo JEONG, resident of Suwon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, and Jin Young CHOI, resident of Seongnam-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, have invented certain new and useful improvements in a "DRYER AND METHOD FOR CONTROLLING THE SAME" disclosed in an application for United States Letters Patent (Application Serial No. 15/874,564, filed _____ on January 18, 2018), said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD, a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: 2018 .01. 17 Seung Eun Chung
Seung Eun CHUNG

Date: _____
Da Eun KIM

Date: _____
Jin Han KIM

Date: _____
Yong Soon PARK

Date: _____
Sung Chan YUN

Date: _____
Dong Woo LEE

Date: _____
Seok-Mo CHANG

Date: _____
Hee-Soo JEONG

Date: _____
Jin Young CHOI

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Date: _____

Sung Chao YUN

Date: 2018 .01 .18

Dong Woo LEE
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Date: 2018 .01 .18

Seok-Mo CHANG
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Hee Soo JEONG
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Date: _____

Jin Han KIM

Date: _____

Yong Soon PARK

Date: Jan 17, 2018


Sung Chan YUN

Date: _____

Dong Woo LEE

Date: _____

Seok-Mo CHANG

Date: _____

Hee-Soo JEONG

Date: _____

Jin Young CHOI